

Features

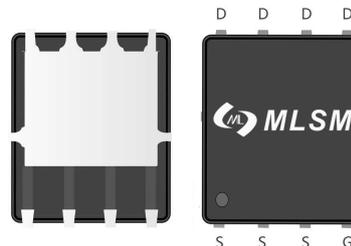
- High density cell design for ultra low R_{ds(on)}
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Product Summary

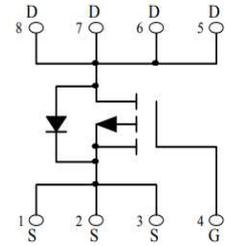
V _{DS}	R _{DS(ON)} MAX	I _D MAX
-60V	35mΩ@-10V	-10A
	50mΩ@-4.5V	

Application

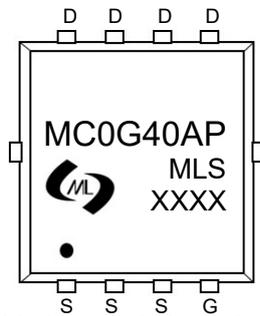
- PWM applications
- Power management
- Load switch



PDFN5X6-8L view



Schematic diagram



Marking and pin assignment

MC0G40AP: Device code
 XXXX : Code



Pb-Free



RoHS



Halogen-Free

Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (T_C=25°C Unless Otherwise Noted)

V _{DS}	Drain-Source Breakdown Voltage	-60	V
V _{GS}	Gate-Source Voltage	±20	V
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
I _S	Diode Continuous Forward Current	T _c =25°C -40	A

Mounted on Large Heat Sink

I _{DM}	Pulse Drain Current Tested	T _c =25°C -160	A
I _D	Continuous Drain Current	T _c =25°C -40	A
P _D	Maximum Power Dissipation	T _c =25°C 25	W
R _{θJA}	Thermal Resistance Junction-to-Ambient	315	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MC0G40AP	PDFN5X6-8L	MC0G40AP	5,000	10,000	70,000	13"reel

Electrical Characteristics (T _J =25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-60V, V _{GS} =0V	--	-	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-1.8	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-20A	--	25	35	mΩ
		V _{GS} =-4.5V, I _D =-10A	--	30	45	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-30V, V _{GS} =0V, f=1MHz	-	3880	-	pF
C _{OSS}	Output Capacitance		-	169	-	pF
C _{RSS}	Reverse Transfer Capacitance		-	138	-	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =-30V, I _D =-10A, V _{GS} =-10V	-	111	-	nC
Q _{gs}	Gate Source Charge		-	25	-	nC
Q _{gd}	Gate Drain Charge		-	15.5	-	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-10V, I _D =-10A, V _{GS} =-10V, R _G =6Ω	--	20	--	nS
t _r	Turn-on Rise Time		-	25	-	nS
t _{d(off)}	Turn-Off Delay Time		-	71	-	nS
t _f	Turn-Off Fall Time		-	30	-	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _J =25°C, I _S =-10A	-	-	-1.2	V

Typical Operating Characteristics

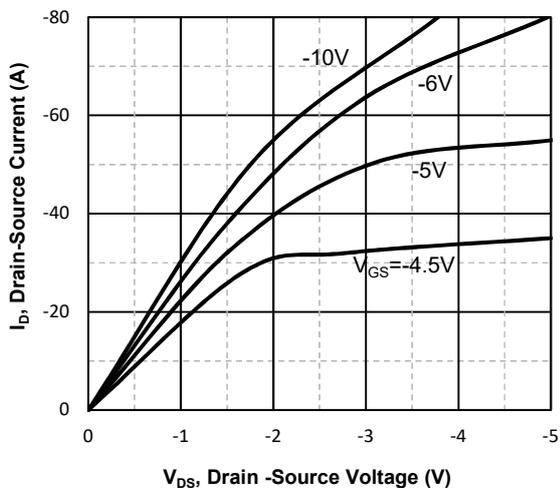


Fig1. Typical Output Characteristics

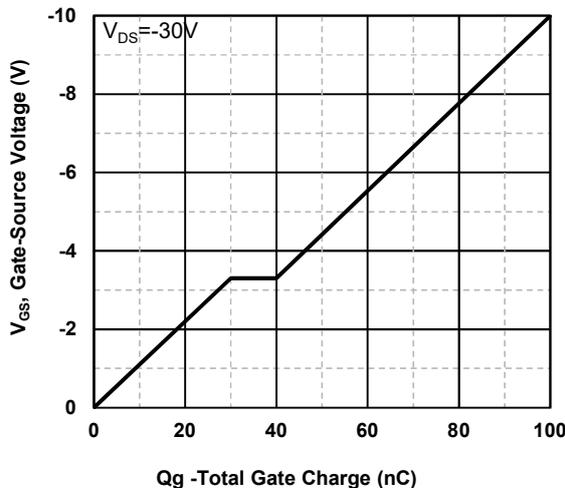


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

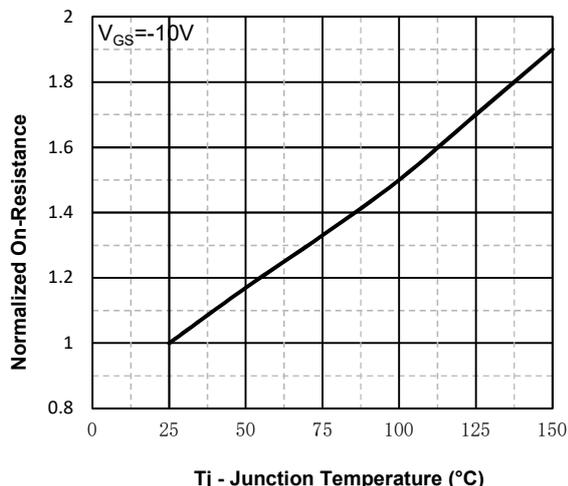


Fig3. Normalized On-Resistance Vs. Temperature

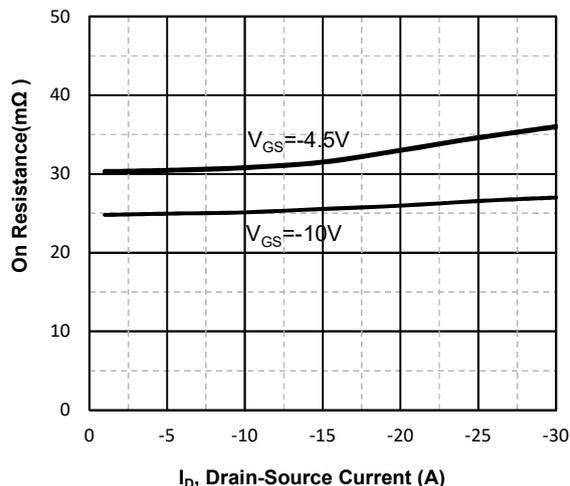


Fig4. Drain-Source on Resistance Vs. Drain-Source Current

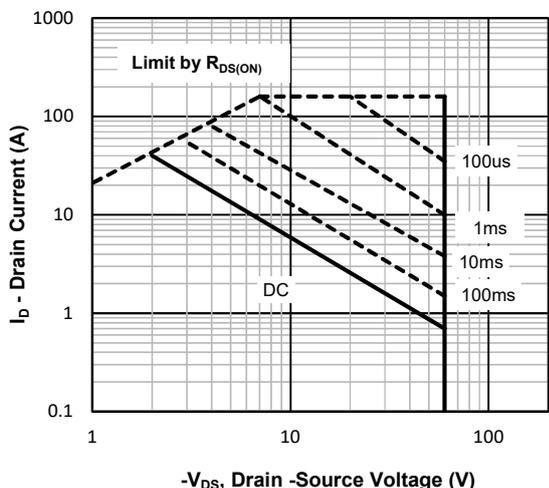


Fig5. Maximum Safe Operating Area

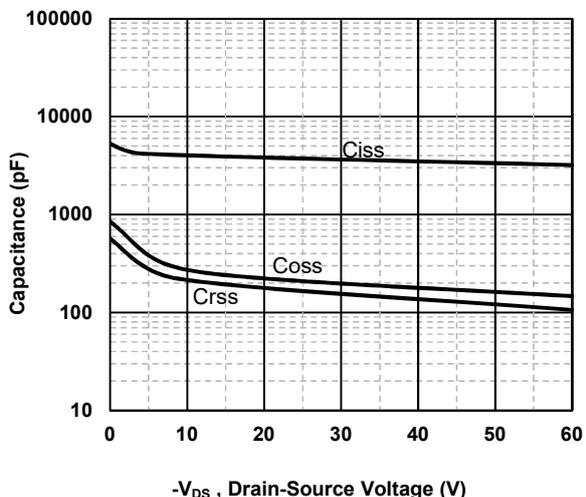
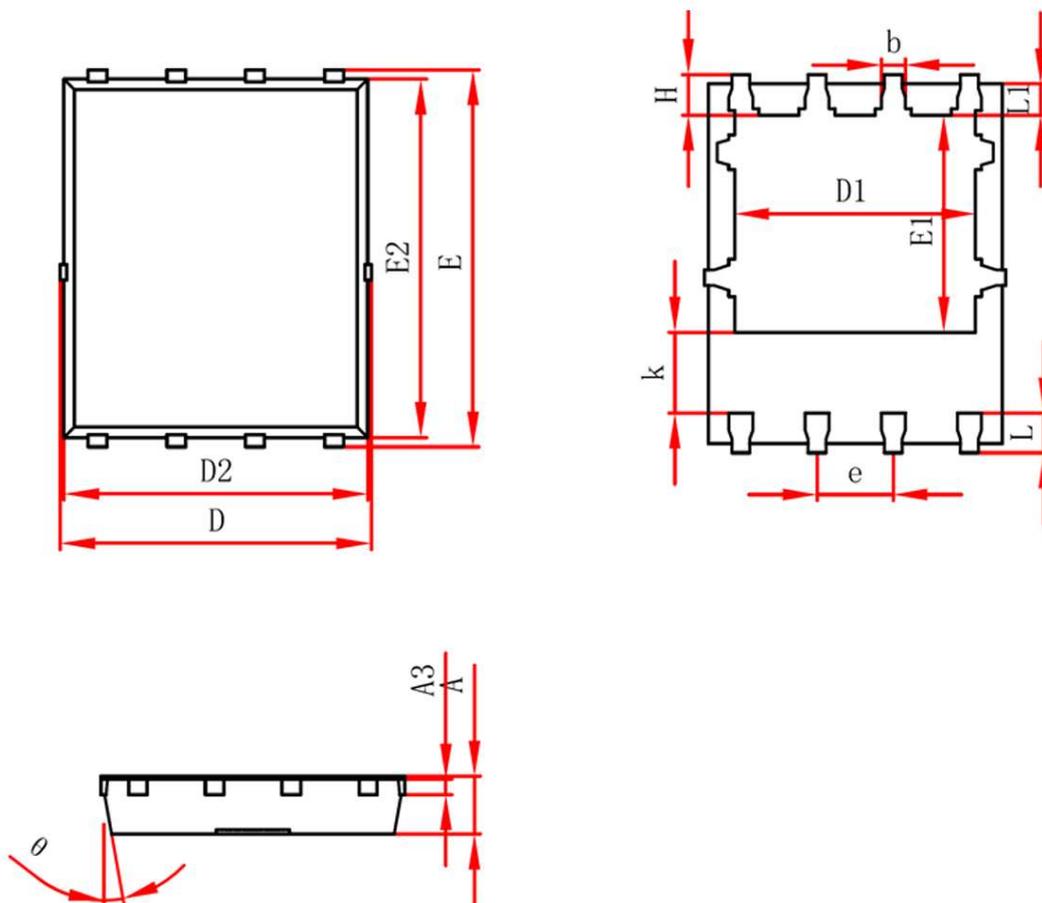


Fig6 Typical Capacitance Vs. Drain-Source Voltage

PDFN5X6-8L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.950	1.050	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.950	5.050	0.196	0.200
E	5.950	6.050	0.235	0.239
D1	4.026	4.126	0.159	0.163
E1	3.510	3.610	0.139	0.143
D2	4.850	4.950	0.192	0.196
E2	5.700	5.800	0.225	0.229
k	1.190	1.390	0.047	0.055
b	0.300	0.400	0.012	0.016
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°